



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 09/827,248
Filing Date April 4, 2001
Inventor David R. Hembree
Assignee Micron Technology, Inc.
Group Art Unit 2829
Examiner V. Nguyen
Attorney's Docket No. MI22-1684
Title: Methods of Processing Wafers and Methods of Communicating Signals With
Respect to a Wafer

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT


References -- See Attached Form PTO-1449

The attached form PTO-1449 is submitted in compliance with 37 CFR §1.56. No admission is made regarding whether all the submitted references are prior art.

Dated: 2/26/04

Attorney:

Respectfully submitted,


James D. Shaurette
Reg. No. 39,833

FL979954-90

Form PTO-1449		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE			ATTY. DOCKET NO. MI22-1684		SERIAL NO. 09/827,348	
<div style="position: relative; height: 100px;"> <div style="position: absolute; top: 0; left: 0; width: 100%; height: 100%; border: 1px solid black; border-radius: 50%; text-align: center; line-height: 100px; font-size: 24px; transform: rotate(-45deg);"> OIPE JUL 16 2004 JG109 </div> </div>					LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)			
					APPLICANT Micron Technology, Inc. FILING DATE April 4, 2001			
U.S. PATENT DOCUMENTS								
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
	AA	4,006,909	2/8/1977	Ollendorf et al.				
	AB							
	AC							
	AD							
	AE							
	AF							
	AG							
	AH							
OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)								
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	AL							
EXAMINER				DATE CONSIDERED				
<small>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</small>								

JUL 16 2004
PATENT & TRADEMARK OFFICE

Form PTO-1449

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICEATTY. DOCKET NO.
MI22-16804PRIORITY SERIAL NO.
09/137,629LIST OF ART CITED BY APPLICANT
(Use several sheets if necessary)APPLICANT
David R. HembreePRIORITY FILING DATE
August 21, 1998PRIORITY GROUP
2858

U.S. PATENT DOCUMENTS

*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	AA	4,560,216	12/24/85	Egawa			
	AB	4,754,555	7/5/88	Stillman			
	AC	5,475,317	12/12/95	Smith			
	AD	5,495,667	3/5/96	Farnworth et al.			

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)

	AE	S/N: 09/032,184; Filed 2/27/98; Akram et al.; Amendment filed 12/18/00; CPA filed 7/28/00; Amendment filed 3/3/00; Amendment filed 8/23/99; Original Application filed 2/27/98; Pending Claims.
	AF	Advertisement for Probe Technology; www.idinet.com ; Interconnect Devices, Inc.; 1 page; 3/6/98
	AG	Good Things Come In Small BGA/CSP Packages; www.johnstech.com/4/handbook/page9.html ; 1 page; 3/5/98
	AH	Product Description for Double Ended Probes, B1052 Series; www.testprobe.com/products/b1052.html ; Rika Denshi America, Inc.; 1 page; 2/4/98.
	AI	Product Description for Test Centers, RM-500 Series Probes, www.testprobe.com/products/rm500.html ; Rika Denshi America, Inc.; 1 page; 2/4/98.
	AJ	Product Description for Cost Effective Interconnections for High I/O Products; www.testprobe.com/products/io.htm#b1303 ; Rika Denshi America, Inc.; 1 page; 2/4/98.
	AK	Product Description for Ball Grid Probe B1303-C3; www.testprobe.com/products/io.htm#b1303 ; Rika Denshi America, Inc.; 1 page; 2/4/98.
	AL	Product Description for Test Socket Contacts; www.johnstech.com/4/handbook/page9.html ; 1 page; 3/5/98

EXAMINER

DATE CONSIDERED

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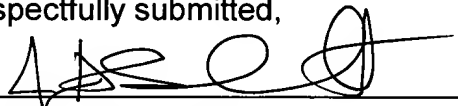
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Dated: 7/16/04

Respectfully submitted,


James D. Shaurette
Reg. No. 39,833

EV372455367

Form PTO-1449				U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO. MI22-1684		SERIAL NO. 09/827,248	
LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)						APPLICANT Micron Technology, Inc.			
						FILING DATE April 4, 2001		GROUP 2858	
U.S. PATENT DOCUMENTS									
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate		
	AA	5,503,034	4/2/1996	Amano et al.					
	AB	5,964,395	2/1/2000	Glovatsky et al.					
	AC	5,645,764	7/1997	Angelopoulos et al.					
	AD	5,437,189	8/1995	Brown et al.					
	AE								
	AF								
	AG								
	AH								
OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)									
	AI								
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